

June 2007

# FSUSB40 — Low-Power, Two-Port, Hi-Speed, USB2.0 (480Mbps) Switch

## **Features**

Low On Capacitance: 5.9pF Typical
 Low On Resistance: 3.9Ω Typical

Low Power Consumption: 1µA Maximum

– 15 $\mu$ A Maximum I $_{CCT}$  over an Expanded Voltage Range (V $_{IN}$ =1.8V, V $_{CC}$ =4.3V)

Wide -3db Bandwidth: > 720MHz

Packaged in:

Pb-free 10-Lead MicroPak™ (1.6 x 2.1mm)

- Pb-free 10-Lead UMLP (1.4 x 1.8mm)

8kV ESD Rating, >16kV Power/GND ESD Rating

Power-Off Protection on All Ports When V<sub>CC=</sub>0V

# **Applications**

Cell phone, PDA, Digital Camera, and Notebook

LCD Monitor, TV, and Set-Top Box

## **IMPORTANT NOTE:**

For additional performance information, please contact analogswitch@fairchildsemi.com.

# Description

The FSUSB40 is a bi-directional, low-power, two-port, Hi-Speed, USB2.0 switch. Configured as a double-pole, double-throw switch (DPDT) switch, it is optimized for switching between two Hi-Speed (480Mbps) sources or a Hi-Speed and Full-Speed (12Mbps) source.

The FSUSB40 is compatible with the requirements of USB2.0 and features an extremely low on capacitance (Con) of 5.9pF. The wide bandwidth of this device (720MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk also minimizes interference.

The FSUSB40 contains special circuitry on the switch I/O pins for applications where the  $V_{\rm CC}$  supply is powered-off ( $V_{\rm CC}$ =0), which allows the device to withstand an over-voltage condition. This device is designed to minimize current consumption even when the control voltage applied to the SEL pin is lower than the supply voltage ( $V_{\rm CC}$ ). This feature is especially valuable to ultra-portable applications, such as cell phones, allowing for direct interface with the general-purpose I/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

# Ordering Information

Part Number	Top Mark	Pb-Free	Operating Temperature Range	Package Package
FSUSB40L10X	HD	Yes	-40 to +8 <mark>5°C</mark>	10-Lead MicroPak™ 1.6 x 2.1mm, JEDEC MO-255B
FSUSB40UMX	НС	Yes	-40 to +85°C	10-Lead, Quad, Ultrathin Molded Leadless Package (UMLP), 1.4 x 1.8mm

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

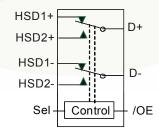


Figure 1. Analog Symbol

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## PRODUCT STATUS DEFINITIONS

# **Definition of Terms**

Datasheet Identification	Product Status	Definition	
Advance Information Formative or In Design		This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.	
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.	

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